



JX011V 1A Sensitive SCR

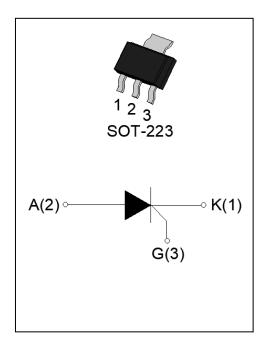
Rev.A.1.0

DESCRIPTION:

The JX011V SCR provides high dV/dt rate with strong resistance to electromagnetic interface. It is especially recommended for use on residual current circuit breaker, straight hair, igniter etc. Package SOT-223 is RoHS compliant.

MAIN FEATURES

Symbol	Value	Unit				
I _{T(RMS)}	1	А				
V _{DRM} /V _{RRM}	800	V				
lgт	≤200	μΑ				



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Storage junction temperature range	T _{stg}	-40-150	$^{\circ}$
Operating junction temperature range	Tj	-40-125 ^①	${\mathbb C}$
Repetitive peak off-state voltage (T _j =25°C)	V _{DRM}	800	V
Repetitive peak reverse voltage (T _j =25°C)	V_{RRM}	800	V
Average on-state current (T _C ≤90°C)	I _{T(AV)}	0.6	Α
RMS on-state current (T _C ≤90°C)	I _{T(RMS)}	1	Α
Non repetitive surge peak on-state current $(t_p=10 \text{ms} , T_j=25 ^{\circ}\text{C})$	I	12	^
Non repetitive surge peak on-state current $(t_p=8.3ms, T_j=25^{\circ}C)$	Ттѕм	13	Α
I²t value for fusing (tp=10ms , Tj=25°C)	l ² t	0.72	A ² s
Critical rate of rise of on-state current (I _G = $2\times$ I _{GT} , f=100Hz , T _j =125 $^{\circ}$ C)	dl/dt	100	A/µs
Peak gate current (t _p =20µs, T _j =125℃)	Івм	1	Α
Average gate power dissipation (T _j =125℃)	P _{G(AV)}	0.1	W

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JX011V



Peak gate power	P _{GM}	2	W
Peak pulse voltage	\/	1	kV
(T _j =25 °C; non-repetitive,off-state;FIG.8)	V_{pp}	I	KV

NOTE 1: When we parallel connect a $\leq 1K\Omega$ resistor between Gate and Cathode, the T_j can reach 125°C; if without this resistor, the T_j only can reach 110°C.

ELECTRICAL CHARACTERISTICS (T_j=25°C unless otherwise specified)

Symbol	Test Condition			Unit	
	rest Condition	MIN.	TYP.	MAX.	Unit
Ідт	V _D =12V R _L =33Ω	-	40	200	μA
V _G т	VD=12V KL=3312	-	0.6	0.8	V
V _{GD}	VD=VDRM Tj=125°C	0.2	-	-	V
IL	Ig=1.2 IgT	-	-	5	mA
lΗ	I _T =0.05A	-	-	4	mA
dV/dt	V _D =540V T _j =125°C R _{GK} =1KΩ	200	-	-	\//uo
V _D =540V T _j =125°C R _{GK} =220Ω		500	-	-	V/µs
ton	I _G =10mA I _A =20mA I _R =2mA	-	2	-	μs
t _{off}	T _j =25℃	-	50	-	μs

STATIC CHARACTERISTICS

Symbol	Parameter		Value(MAX.)	Unit
V _{TM}	I _T =2A t _p =380μs	T _j =25℃	1.4	V
Vто	Threshold voltage	T _j =125℃	0.8	V
R₀	Dynamic Resistance	T _j =125℃	0.1	Ω
I _{DRM}	VD=VDRM VR=VRRM	T _j =25℃	5	μΑ
I _{RRM}	VD=VDRM VR=VRRM	T _j =125℃	0.2	mA

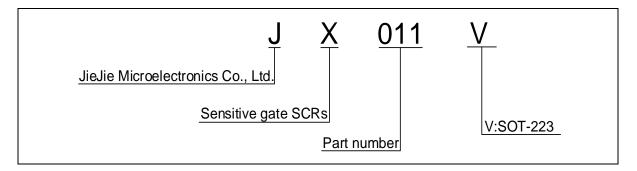
THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R _{th(j-c)}	junction to case (DC)	30	°C/W
R _{th(j-a)}	junction to ambient (DC)	125	°C/W

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ORDERING INFORMATION



MARKING

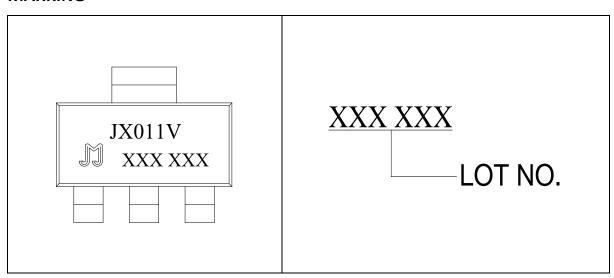


FIG.1 Maximum power dissipation versus RMS on-state current

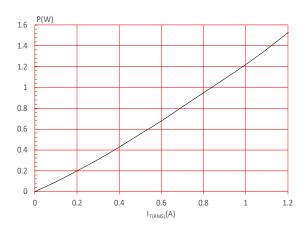


FIG.3: RMS on-state current versus ambient temperature (printed circuit board FR4,copper thickness:35µm)(full cycle)

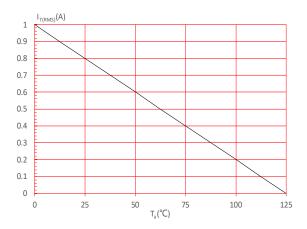


FIG.5: On-state characteristics

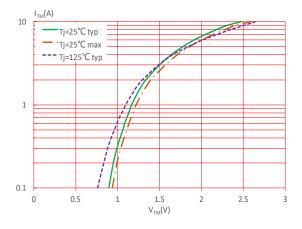


FIG.2: RMS on-state current versus case temperature

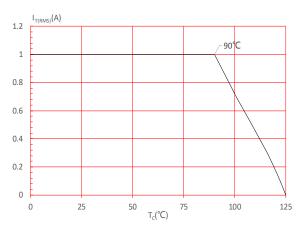


FIG.4: Surge peak on-state current versus number of cycles

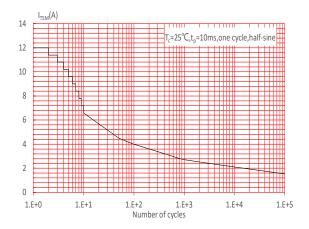


FIG.6: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 10ms$, and corresponding value of I^2t (dl/dt<100A/ μ s)

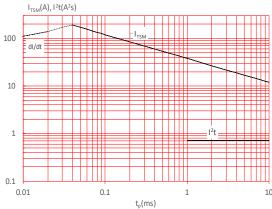


FIG.7: Relative variations of gate trigger current, holding current and latching current versus junction temperature

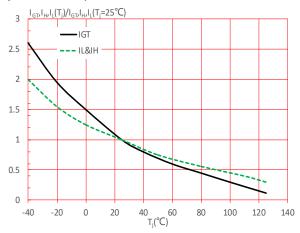
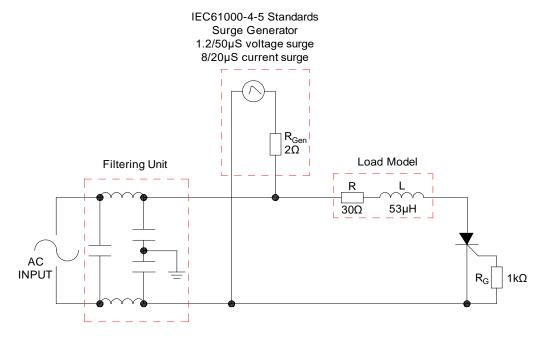
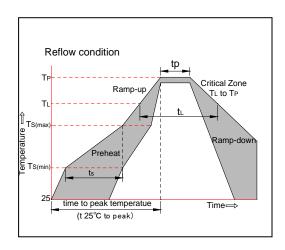


FIG.8: Test circuit for inductive and resistive loads to IEC-61000-4-5 standards.



SOLDERING PARAMETERS

Reflow C	ondition	Pb-Free assembly (see figure at right)
	-Temperature Min (T _{s(min)})	+150℃
Pre Heat	-Temperature Max $(T_{s(max)})$	+200℃
-Time (Min to Max) (ts)		60-180 secs.
1	ramp up rate Temp (T _L)to peak)	3℃/sec. Max
T _{s(max)} to	T _L - Ramp-up Rate	3°C/sec. Max
Reflow	-Temperature(T _L) (Liquidus)	+217℃
	-Temperature(t _L)	60-150 secs.
Peak Ten	np (T _p)	+260(+0/-5)°C
Time with Peak Ten	in 5°Cof actual np (t _p)	20-40secs.
Ramp-down Rate		6℃/sec. Max
Time 25°	to Peak Temp (T _P)	8 min. Max
Do not ex	ceed	+260℃



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ORDERING INFORMATION

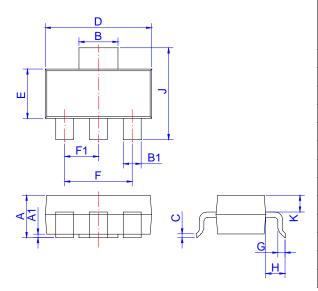
Order code	Voltage V _{DRM} /V _{RRM} (V)	IGT(μA)	Package	Base qty. (pcs)	Delivery mode
JX011V	800	≤200	SOT-223	4,000	Tape & Reel

Document Revision History

Date	Revision	Changes
Apr.12, 2023	A.1.0	Last update

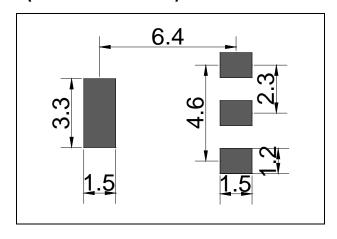


PACKAGE MECHANICAL DATA



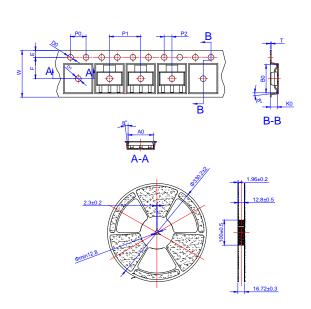
	Dimensions						
Ref.		Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	1.5	1.6	1.8	0.059	0.063	0.071	
A1	0.01	0.06	0.10	0.001	0.002	0.004	
В	2.9	3.0	3.1	0.114	0.118	0.122	
B1	0.6	0.7	0.8	0.024	0.028	0.031	
С	0.22	0.26	0.32	0.009	0.010	0.013	
D	6.3	6.5	6.7	0.248	0.256	0.264	
Е	3.3	3.5	3.7	0.130	0.138	0.146	
F	4.4		4.8	0.173		0.189	
F1	2.2		2.4	0.087		0.094	
G	0.5		1.0	0.020		0.039	
Н	1.5	1.75	2.0	0.059	0.069	0.079	
J	6.7	7.0	7.3	0.264	0.276	0.287	
K	0.8	0.9	1.0	0.031	0.035	0.039	

FOOTPRINT-SOT-223 (dimensions in mm)





DELIVERY MODE



	Dimensions					
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
W	-	-	12.30	-		0.482
E	1.65	1.75	1.85	0.065	0.069	0.073
F	5.45	5.50	5.55	0.215	0.217	0.219
D0	1.50	1.55	1.60	0.059	0.061	0.063
D1	1.50	-	-	0.059	-	-
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.95	2.00	2.05	0.077	0.079	0.081
10P0	39.80	40.00	40.20	1.567	1.575	1.583
A0	6.85	6.95	7.05	0.269	0.273	0.276
В0	7.15	7.25	7.35	0.280	0.284	0.288
K0	1.95	2.05	2.15	0.076	0.080	0.084
Т	0.20	0.25	0.30	0.008	0.010	0.012

PACKAGE	OUTLINE	REEL (PCS)	PER CARTON (PCS)	TAPE & REEL
SOT-223	TAPING	4,000	40,000	13 inch

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